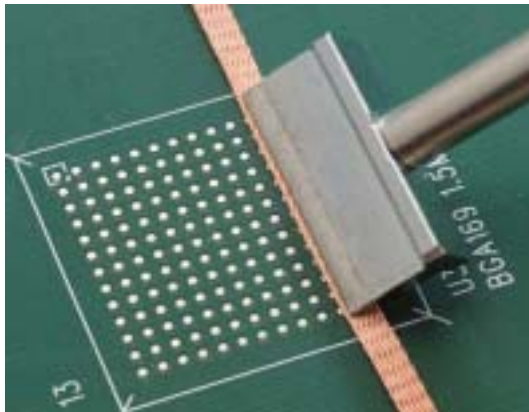


BGA REBALLING



1. BGA

BGA CHIP PCB

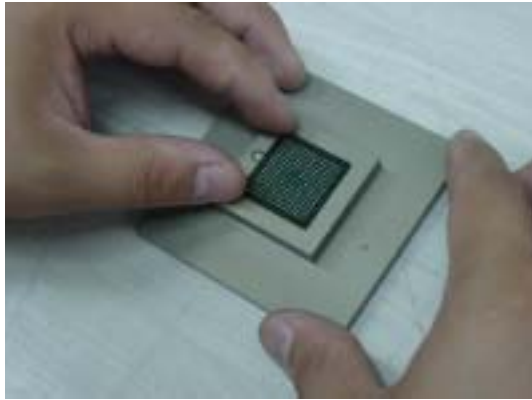


2. BGA CHIP

SOLDER WICK



3. BGA CHIP



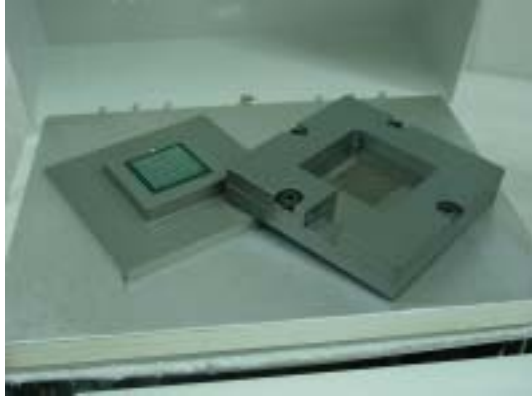
4. BGA CHIP FIXTURE



5. FIXTURE



6. SOLDER BALL FIXTURE BALL
BALL



7. FIXTURE HOT PLATE . 240 4 가 .



8. 가 FIXTURE COOLING PLATE CHIP .

BGA Reballing



BGA

PCB

100%가

가

0.5Φ

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